

## Absorption of IR radiation in silicon-based diffusion layers

*D. S. Konorev*<sup>1</sup>, *E. A. Klimanov*<sup>2</sup>, *R. V. Davletshin*<sup>2</sup> and *E. A. Makarova*<sup>2</sup>

<sup>1</sup>National University of Science and Technology “MISiS”  
Bd. 1, 4 Leninsky Ave., Moscow, 119049, Russia

<sup>2</sup>Orion R&P Association, JSC  
9 Kosinskaya st., Moscow, 111538, Russia

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***The experimental data on transmissivity of heavily doped diffusion layers as function of their sheet resistance and wavelength of radiation with accounting free carrier absorption in diffused layers are given. It gives requirements to these layers parameters for reduce this effect on transmissivity. It is shown also, that silicon structure transmissivity data over 1.25 microns wavelength agree with theoretical results with accounting strong dependent free carrier mobilities on concentration doping impurities.***

***Keywords:*** Si, silicon, spectral transmission, free carriers, electron concentration, surface resistance.

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